SYNCHRONOUS DRAM

# SYNCHRONOUS DRAM

## 4 MEG x 4 SDRAM

Pulsed RAS, Dual Bank, BURST Mode, 3.3V, SELF REFRESH

#### **FEATURES**

- Fully synchronous; all signals (excluding clock enable) registered to positive edge of system clock
- Meets all JEDEC functional specifications
- Dual internal banks: dual 2 Meg x 4 architecture
- Programmable burst-lengths: 2, 4, 8 cycles or full-page burst
- · Programmable burst-sequence: sequential or interleave
- Burst termination
- · Multiple burst READ, single WRITE capability
- Hidden precharge capability with optional automatic precharge command
- Programmable READ latency: 1, 2 or 3 clocks
- Industry-standard x8 pinouts, timing, functions and packages
- Refresh modes: AUTO and SELF
- Standard and extended AUTO REFRESH rates
- High-performance CMOS silicon-gate process
- Lead-over-chip assembly architecture
- Single +3.3V ±0.3V power supply
- Low power, 3mW standby; 200mW active, typical
- LVTTL-compatible
- CKE-controlled power-down and suspend operations
- Mode register programming
- JEDEC-standard command set (pulsed RAS)

OPTIONS	MARKING
Timing	
10ns access (≤100 MHz)	-10
12ns access (≤83 MHz)	-12
13.3ns access ( ≤75 MHz)	-13
• Auto Refresh 4,096-cycle in 64ms (15.6μs/rov 4,096-cycle in 128ms (31.25μs/rov	,
• SELF REFRESH Not allowed Allowed	none S
<ul> <li>Plastic Packages</li> <li>44-pin TSOP (400 mil)—forward</li> </ul>	TG

Part Number Example: MT48LC4M4R1TG-10 S

#### GENERAL DESCRIPTION

The MT48LC4M4R1(S) is a randomly accessed, solidstate memory containing 16,777,216 bits organized in a x4

#### PIN ASSIGNMENT (Top View)

#### 44-Pin TSOP FORWARD (DD-7)

Vcc	d	1		44	ь	Vss
NC	Н	2		43	В	NC
VssQ	Ш	3		42	Ð	VssQ
DQ1	Œ	4				DQ4
VccQ	п	5				VccQ
NC						NC
VssQ			C			VssQ
DQ2			F			DQ3
VccQ			MT48C4M4R1TG			VccQ
NC			4			NC
NC			Ś			NC
WE			<del>4</del>			DQM
CAS			တ္က			CLK
RAS			₩			CKE
CS			⊨			NC
BA			2			A9
A10						A8
AO						A7
A1	Œ	19		26	Þ	<b>A</b> 6
A2	Ш	20				<b>A</b> 5
<b>A</b> 3	Н	21		24	Þ	A4
Vcc	Œ	22		23	Þ	Vss
		_			,	

with a synchronous interface. Each byte is uniquely addressed through a bank-select bit and 20 address bits. The bank select and address are entered first by RAS registering (row active command) 12 bits (A0-A10, BA) and then CAS registering 11 bits (A0-A9, BA). At CAS registration (READ or WRITE command), address bit A10 defines autoprecharge state (active HIGH). Bank selection is controlled by BA during both RAS and CAS registration.

The MT48LC4M4R1 is designed to operate in a synchronous, 3.3V memory system. All input and output signals, with the exception of clock enable (CKE) during POWER-DOWN and SELF REFRESH modes, are synchronized to the positive-going edge of the system clock (CLK).

The synchronous DRAM has several programmable features to allow maximum performance in each user's system. Additionally, bank switching between the two internal memory banks in conjunction with the programmable BURST mode provides very high-speed performance.

The synchronous DRAM allows both AUTO REFRESH (during normal operation) and SELF REFRESH (for low-



### **FUNCTIONAL BLOCK DIAGRAM**

